

## General Description:

9N20, the silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency. The package form is TO-220F, which accords with the RoHS standard.

## Features:

- Fast Switching
- Low ON Resistance( $R_{DS(on)} \leq 0.28\Omega$ )
- Low Gate Charge (Typical Data: 12.6nC)
- Low Reverse transfer capacitances(Typical: 8.8pF)
- 100% Single Pulse avalanche energy Test

## Applications:

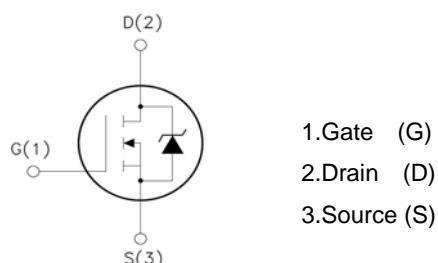
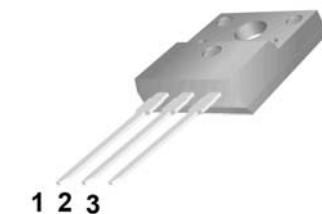
Power switch circuit of adaptor and charger.

### Absolute (T<sub>c</sub> = 25°C unless otherwise specified):

Symbol	Parameter	Rating	Units
V <sub>DSS</sub>	Drain-to-Source Voltage	200	V
I <sub>D</sub>	Continuous Drain Current	9	A
	Continuous Drain Current T <sub>c</sub> = 100 °C	5.4	A
I <sub>DM</sub> <sup>a1</sup>	Pulsed Drain Current	36	A
V <sub>GS</sub>	Gate-to-Source Voltage	±30	V
E <sub>AS</sub> <sup>a2</sup>	Single Pulse Avalanche Energy	200	mJ
dv/dt <sup>a3</sup>	Peak Diode Recovery dv/dt	5.0	V/ns
P <sub>D</sub>	Power Dissipation	30	W
	Derating Factor above 25 °C	0.24	W/°C
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Storage Temperature Range	150, -55 to 150	°C
T <sub>L</sub>	Maximum Temperature for Soldering	300	°C

V <sub>DSS</sub>	200	V
I <sub>D</sub>	9	A
P <sub>D</sub> (T <sub>c</sub> =25 °C)	30	W
R <sub>DS(ON)Typ</sub>	0.24	Ω

TO-220F



**Electrical Characteristics** (T<sub>c</sub>= 25°C unless otherwise specified):

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Unit
			Min.	Typ.	Max.	
V <sub>DSS</sub>	Drain to Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	200	--	--	V
Δ BV <sub>DSS</sub> / Δ T <sub>J</sub>	Bvdss Temperature Coefficient	I <sub>D</sub> =250uA, Reference 25°C	--	0.25	--	V/°C
I <sub>DSS</sub>	Drain to Source Leakage Current	V <sub>DS</sub> = 200V, V <sub>GS</sub> = 0V, T <sub>a</sub> = 25°C	--	--	1	μA
		V <sub>DS</sub> = 160V, V <sub>GS</sub> = 0V, T <sub>a</sub> = 125°C	--	--	100	μA
I <sub>GSS(F)</sub>	Gate to Source Forward Leakage	V <sub>GS</sub> = +30V	--	--	100	nA
I <sub>GSS(R)</sub>	Gate to Source Reverse Leakage	V <sub>GS</sub> = -30V	--	--	-100	nA

ON Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
R <sub>DS(ON)</sub>	Drain-to-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =4.5A	--	0.24	0.28	Ω
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	--	4.0	V
Pulse width tp ≤ 300 μs, δ ≤ 2%						

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
g <sub>fs</sub>	Forward Trans conductance	V <sub>DS</sub> =15V, I <sub>D</sub> = 4.5A	--	5	--	S
R <sub>g</sub>	Gate resistance	f = 1.0MHz		2.6		Ω
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V V <sub>DS</sub> = 25V f = 1.0MHz	--	550	--	pF
C <sub>oss</sub>	Output Capacitance		--	94	--	
C <sub>rss</sub>	Reverse Transfer Capacitance		--	8.8	--	

Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
t <sub>d(ON)</sub>	Turn-on Delay Time	I <sub>D</sub> = 9A V <sub>DD</sub> = 100V R <sub>G</sub> = 10Ω	--	10.9	--	ns
t <sub>r</sub>	Rise Time		--	3.5	--	
t <sub>d(OFF)</sub>	Turn-Off Delay Time		--	19.2	--	
t <sub>f</sub>	Fall Time		--	4.5	--	
Q <sub>g</sub>	Total Gate Charge	I <sub>D</sub> = 9A V <sub>DD</sub> = 160V V <sub>GS</sub> = 10V	--	12.6	--	nC
Q <sub>gs</sub>	Gate to Source Charge		--	3.1	--	
Q <sub>gd</sub>	Gate to Drain ("Miller") Charge		--	5.8	--	

**Source-Drain Diode Characteristics**

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I <sub>S</sub>	Continuous Source Current (Body Diode)		--	--	9	A
I <sub>SM</sub>	Maximum Pulsed Current (Body Diode)		--	--	36	A
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =9.0A, V <sub>GS</sub> =0V	--	--	1.5	V
trr	Reverse Recovery Time	I <sub>S</sub> =9.0A, T <sub>j</sub> = 25°C dI <sub>F</sub> /dt=100A/us, V <sub>GS</sub> =0V	--	112.7	--	ns
Qrr	Reverse Recovery Charge		--	476	--	nC
I <sub>RRM</sub>	Reverse Recovery Current		--	8	--	A
Pulse width t <sub>p</sub> ≤300μs, δ ≤2%						

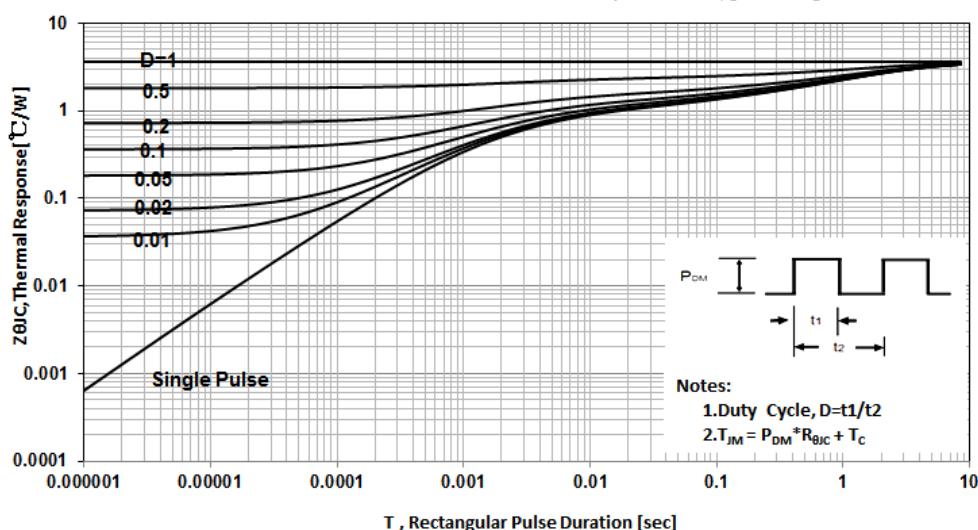
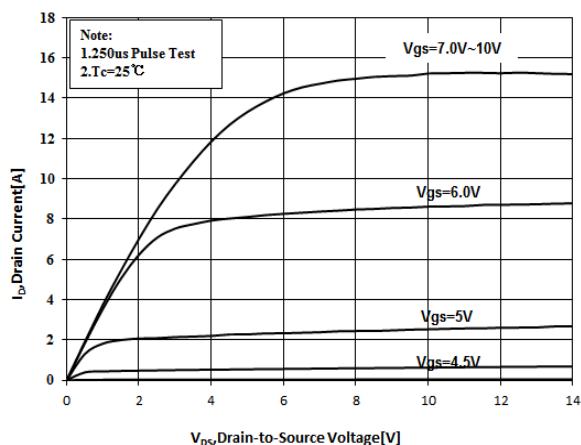
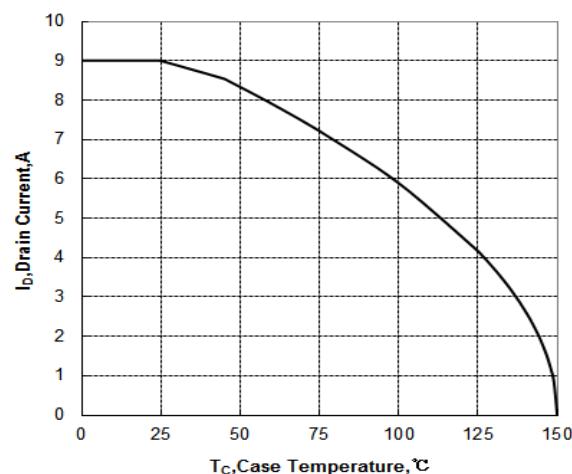
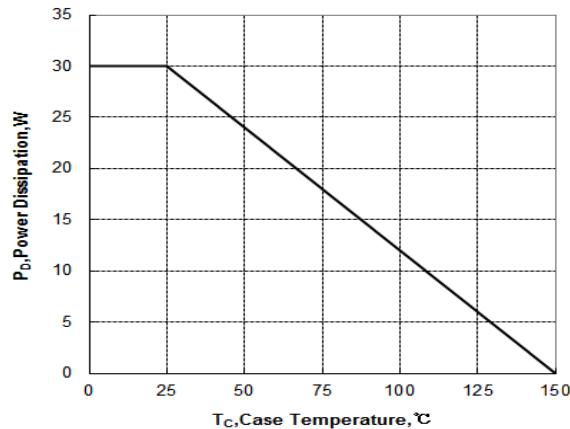
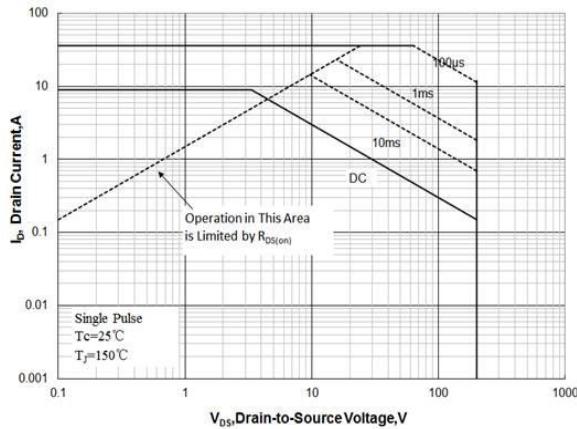
Symbol	Parameter	Max.	Units
R <sub>θ JC</sub>	Junction-to-Case	4.17	°C/W
R <sub>θ JA</sub>	Junction-to-Ambient	62.5	°C/W

<sup>a1</sup>: Repetitive rating; pulse width limited by maximum junction temperature

<sup>a2</sup>: L=10mH, I<sub>D</sub>=6.4A, Start T<sub>j</sub>=25°C

<sup>a3</sup>: I<sub>SD</sub>=9A,di/dt ≤100A/us,V<sub>DD</sub>≤BV<sub>DS</sub>, Start T<sub>j</sub>=25°C

### Characteristics Curve:



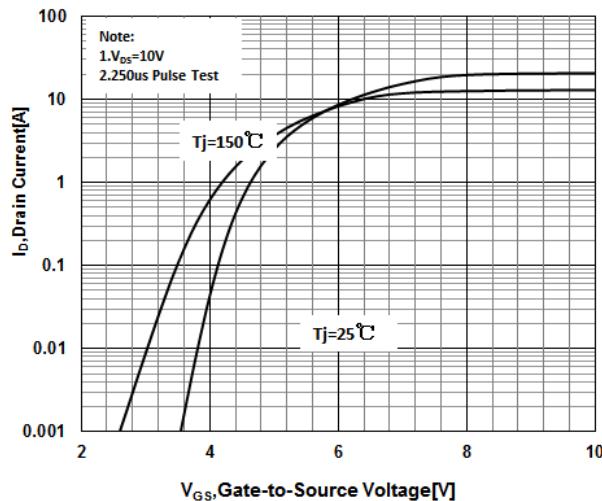


Figure 6 Typical Transfer Characteristics

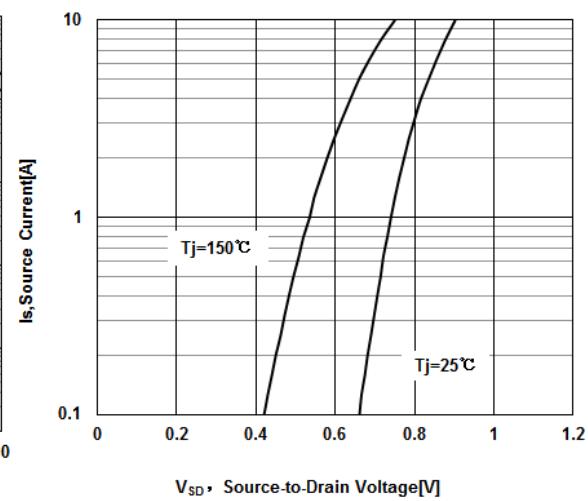


Figure 7 Typical Body Diode Transfer Characteristics

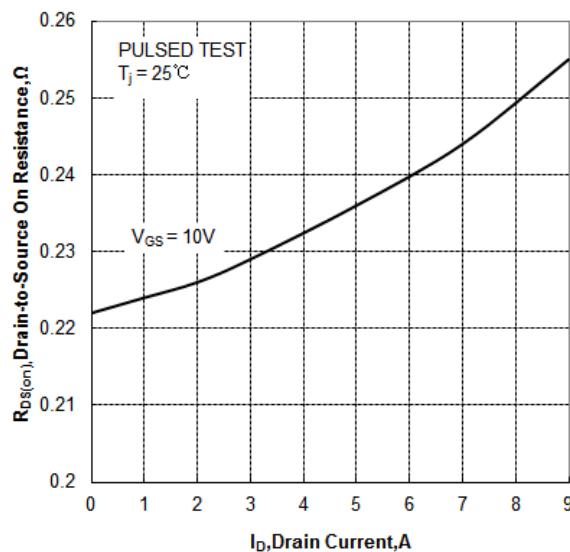


Figure 8 Typical Drain to Source ON Resistance vs Drain Current

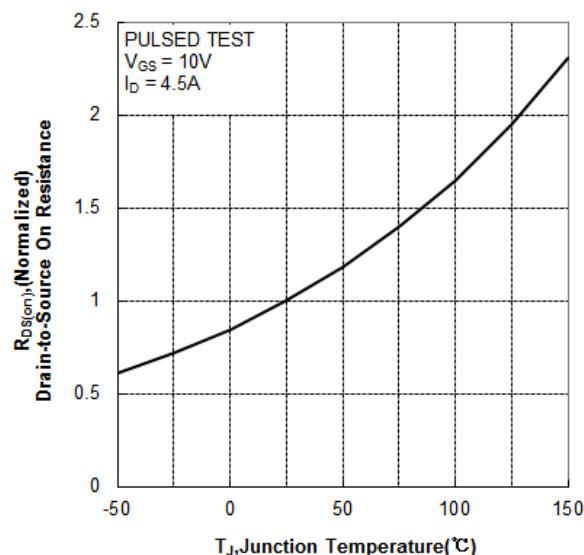


Figure 9 Typical Drian to Source on Resistance vs Junction Temperature

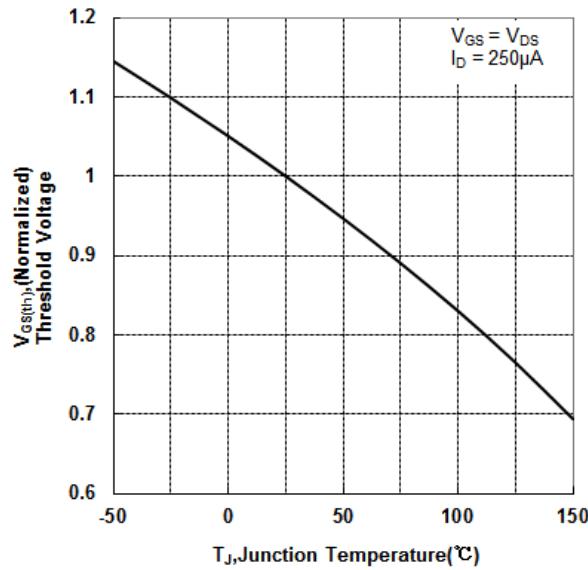


Figure 10 Typical Threshold Voltage vs Junction Temperature

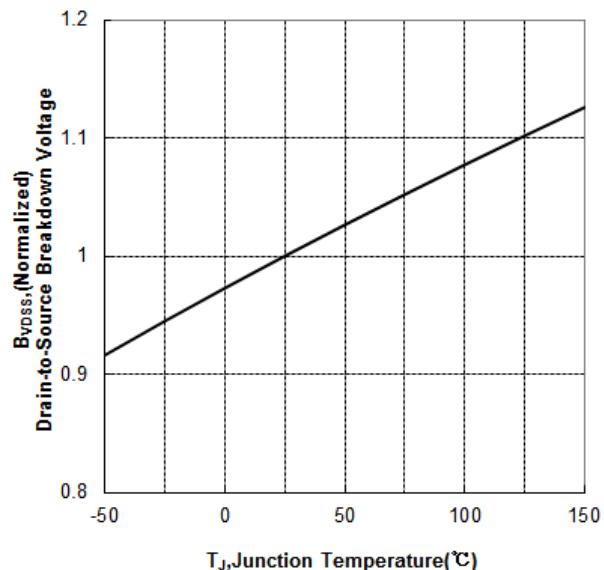


Figure 11 Typical Breakdown Voltage vs Junction Temperature

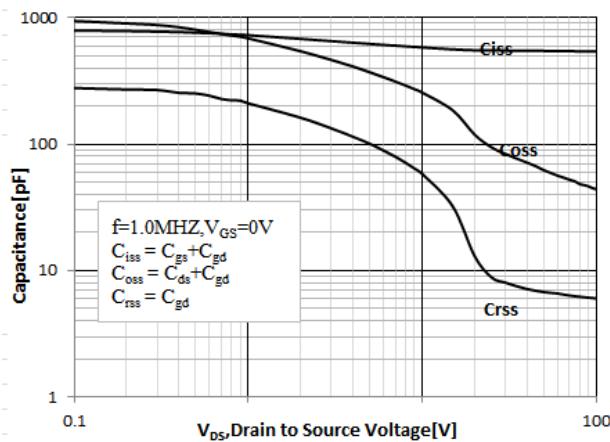


Figure 12 Typical Capacitance vs Drain to Source Voltage

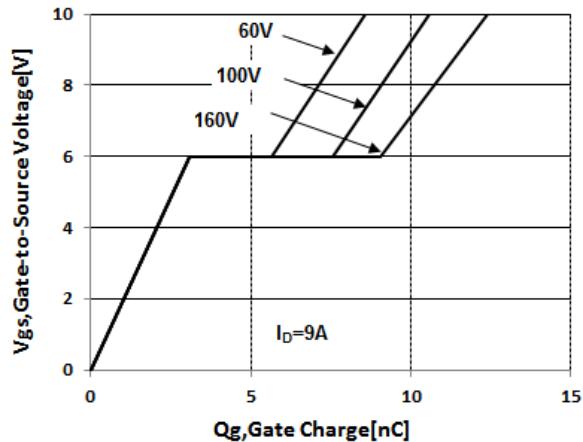


Figure 13 Typical Gate Charge vs Gate to Source Voltage

### Test Circuit and Waveform:

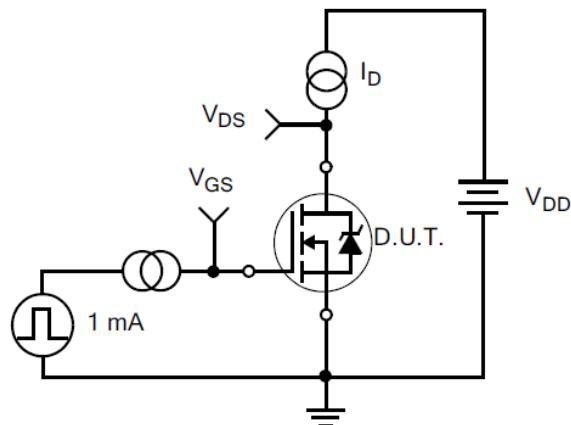


Figure 14. Gate Charge Test Circuit

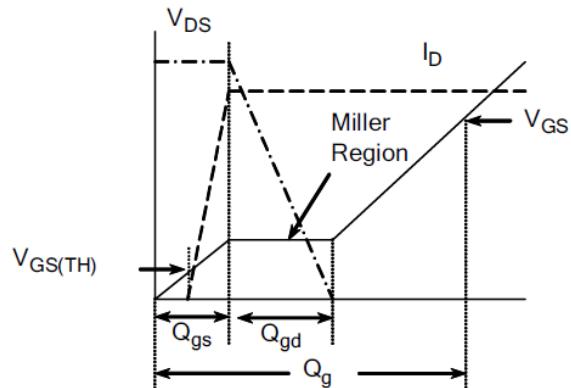


Figure 15. Gate Charge Waveforms

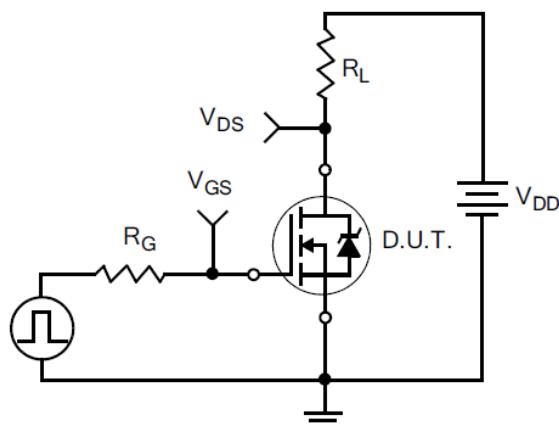


Figure 16. Resistive Switching Test Circuit

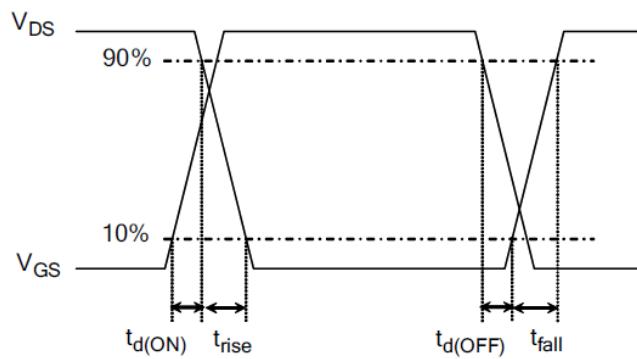


Figure 17. Resistive Switching Waveforms

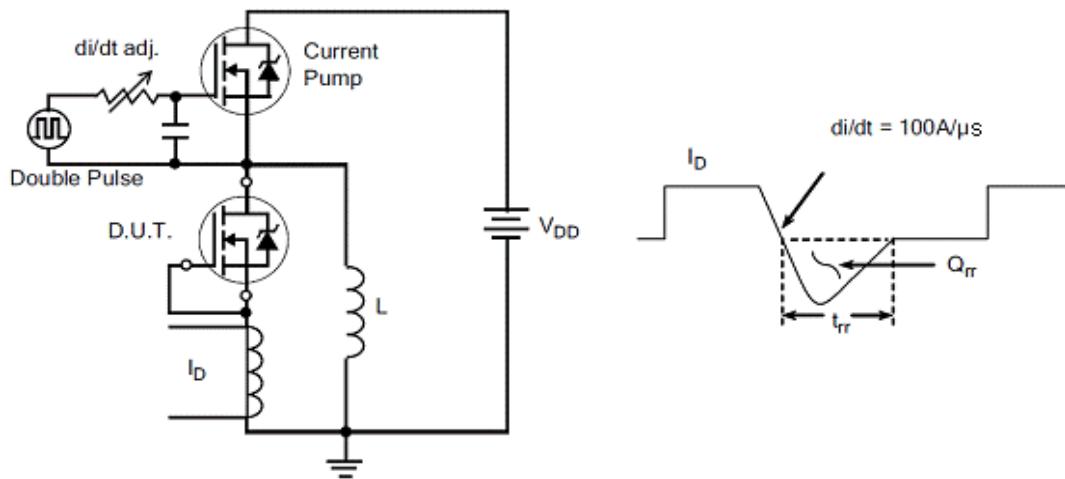


Figure 18. Diode Reverse Recovery Test Circuit

Figure 19. Diode Reverse Recovery Waveform

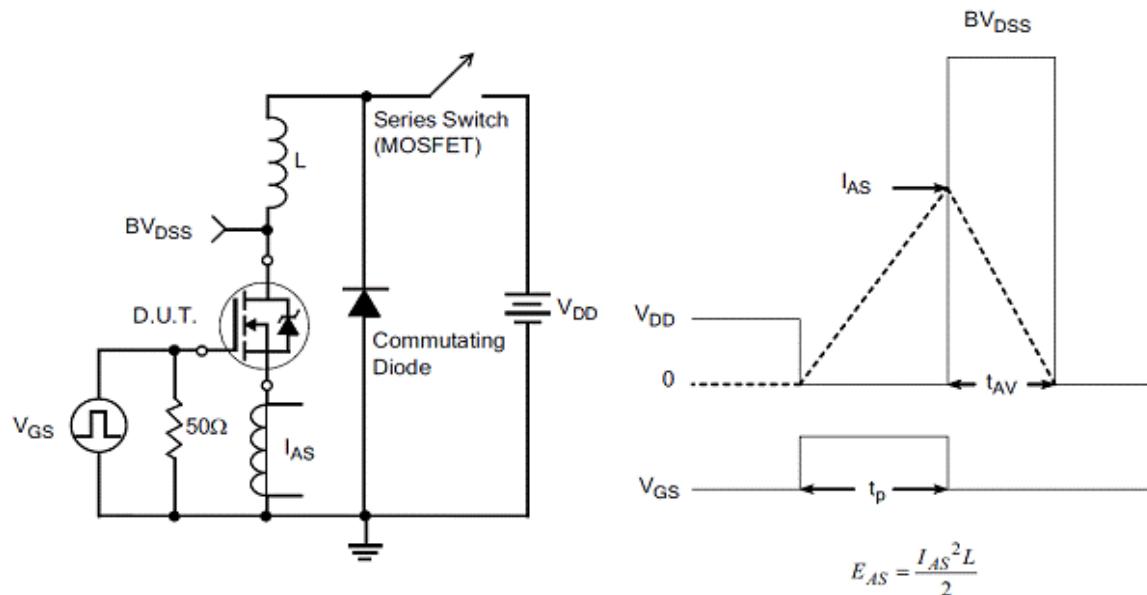
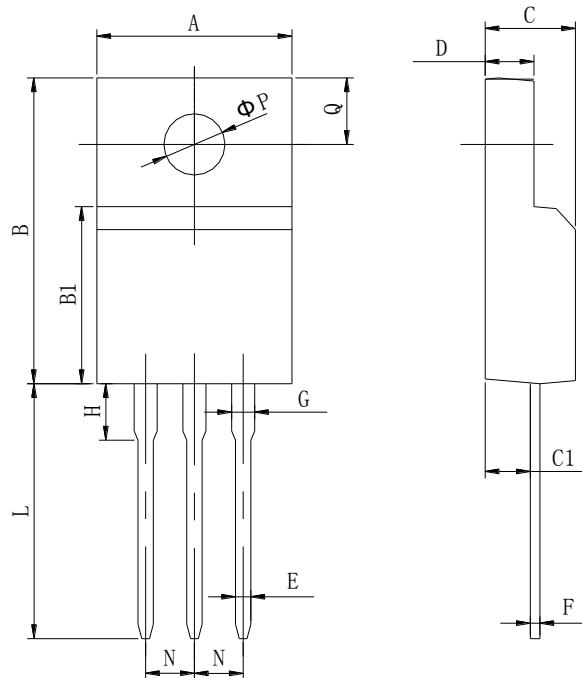


Figure 20. Unclamped Inductive Switching Test Circuit

Figure 21. Unclamped Inductive Switching Waveform

**Package Information:**


Items	Values(mm)	
	MIN	MAX
A	9.60	10.4
B	15.4	16.2
B1	8.90	9.50
C	4.30	4.90
C1	2.10	3.00
D	2.40	3.00
E	0.60	1.00
F	0.30	0.60
G	1.12	1.42
H	3.40	3.80
L*	12.0	14.0
N	2.34	2.74
Q	3.15	3.55
ΦP	2.90	3.30

\*adjustable

TO-220F Package